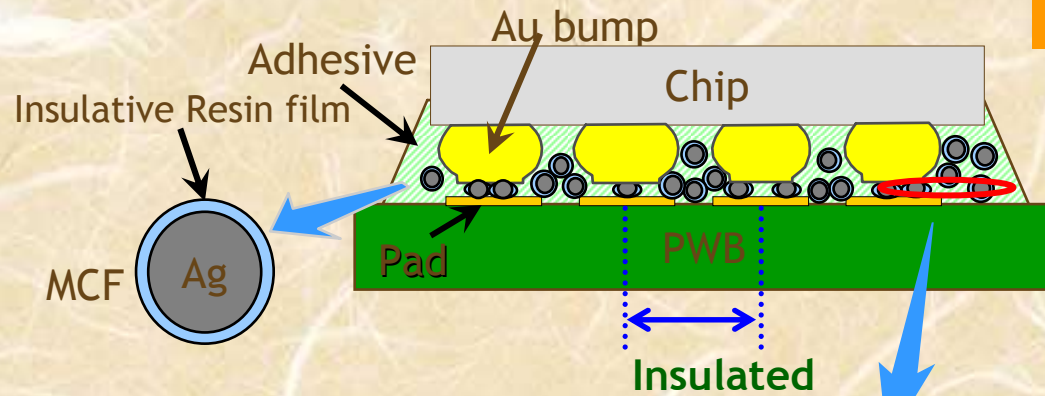


Anisotropic conductive adhesive, Micro capsule type

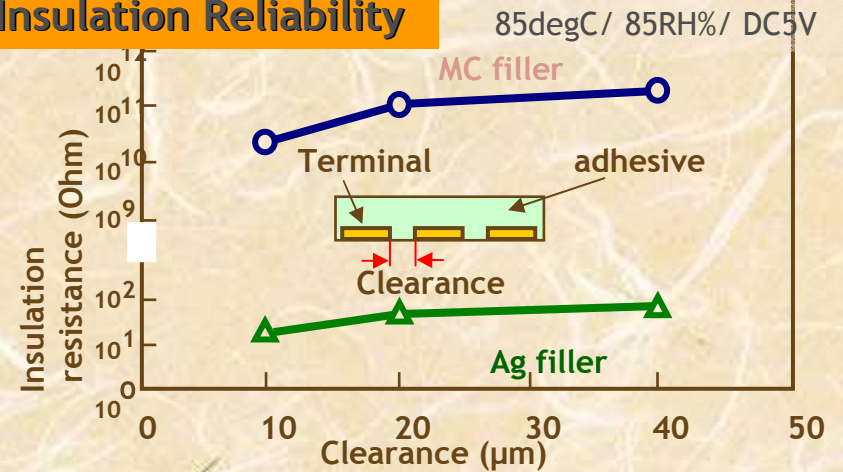
- Larger terminal counts, fine pitch -

Ensure the conductivity by adding metal filler
Insulation reliability between terminals

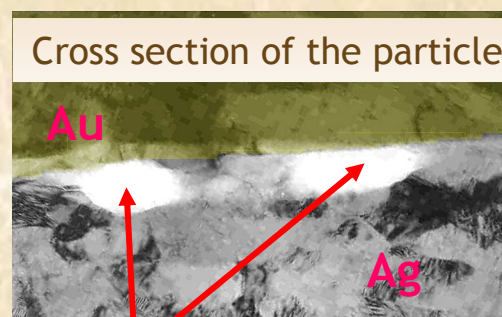
Micro capsule realizes



Insulation Reliability



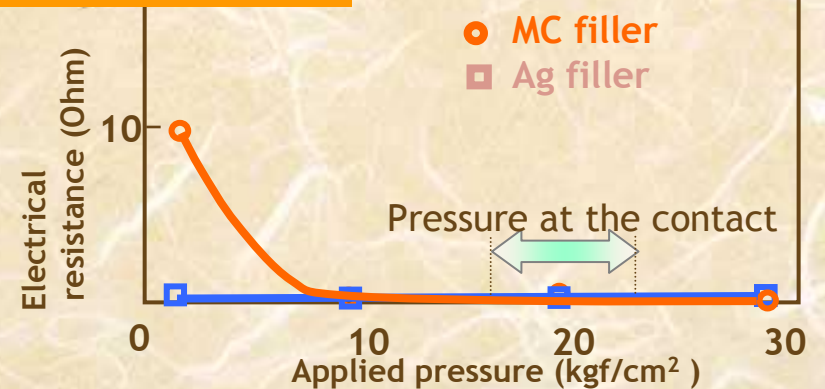
10 μm



Insulative Resin

0.1 μm

Conductivity



For bonding HDD head amplifier IC